Tender Notification for the procurement of a "In-situ micro-mechanical testing system with EBSD" at IISc, Bangalore (Last Date for submission of tenders: 13th March 2017)

Dear Sir/Madam,

Kindly send your best quotation for the following item on C.I.P. Bangalore basis. Your quotation should clearly indicate the terms of delivery, delivery schedule, E.D., payment terms etc. The tender should be submitted in two separate sealed envelopes - one containing the technical bid and the other containing the commercial bid, both of which should reach us, duly signed on or before 1700 hours 13th March (Monday), 2017.

Please enclose a compliance certificate along with the technical bid.

Specifications for the product

Item	Mus	have requirement	Optional requirement
Testing modes	 Tension and compression at all temperatures 3- and 4-points bend tests at room temperature 		 Torsion 3- and 4-point bend tests at all temperatures
Tests	 Standard displacement rate controlled test, creep, stress relaxation, fatigue and fatigue with hold-time at maximum and minimum load Single software package for performing all tests 		 Constant true strain rate tests Constant true stress tests Stress and strain rate jump tests
Minimum sample size for tension test (l x w x h)	$\leq 200 \ \mu m \ x \ 100 \ \mu m \ x \ 50 \ \mu m$		\leq 200 μm x 100 μm x 10 μm
Maximum sample size for tension test (l x w x h)	\geq 25 mm x 10 mm x 4 mm		
Load Specifications			
Maximum load 2		kN	
Load step 0.		.1 % of the maximum load	
Load resolution 0.		.1 % of the load cell	
Displacement Specification	5		
Maximum displacement rate		\geq 50 μ m/s	
Minimum displacement rate		\leq 5 μ m/s	
Resolution in displacement rate		\leq 0.1 μ m/s	
Maximum displacement		\geq 25 mm	

Resolution in displacement	≤ 0.1 μm	
Temperature Specifications	· ·	I
Maximum Test Temperature	\geq 500 °C (for tension and compression) in SEM level vacuum	
Temperature stability	± 1 °C	± 0.1 °C
Temperature steps:	≤ 0.5 °C	
Temperature measurement independent of temperature controller	Yes	
Minimum time to reach 500 °C from room temperature	$\leq 1 \text{ hr}$	
Environment required for performing tests at 500 °C	Vacuum (ordinary SEM level vacuum)	Ambient
EBSD		
Stage and attachments for EBSD	Capable of performing EBSD at room temperature as well as high temperatures	
Other optional test facility		Fatigue Maximum Frequency ≥1Hz R-Ratio ≥ ±1
Data Acquisition Specifications		
Format for data export	Text, Excel, CSV	ASCII
	Text, Excel, CSV Additional channels in main controller / software for recording at least one extra load, temperature and displacement sensor data from sensors other than provided by vendor	
Format for data export Additional input data channels Miscellaneous	Additional channels in main controller / software for recording at least one extra load, temperature and displacement sensor data from sensors other than	
Format for data export Additional input data channels Miscellaneous Drive motor	Additional channels in main controller / software for recording at least one extra load, temperature and displacement sensor data from sensors other than provided by vendor	
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Terms and Conditions

- 1. Two bid system (separate technical and financial bids) in sealed tenders
- 2. The technical bid must clearly specify the prescribed technical specifications without including the prices. Vendors who include price information in the technical bids will be automatically disqualified.
- 3. Technical bids will be opened first. IISc may seek clarifications after opening of technical bids, and may ask them to perform in a short time (1 week) some example experiments with their set up on the sample given by IISc to demonstrate the promised technical specifications. Vendors may be required to give presentations. There are several items that require information to be provided by the supplier. If information is not provided against any of these items, this will disqualify the supplier. After technical evaluation by a committee, vendors may be asked to re-quote in a specific format to facilitate comparison of prices. IISc also reserves the right to cancel the tender at any time without assigning any reason whatsoever.
- 4. Price bids of only technically qualified vendors will be considered and the vendors will be informed the day of opening the price bids.
- 5. The price bids must offer CIF Bangalore prices.
- 6. Prices to be quoted separately for baseline system and options. Prices will should be quoted in adequate detail with relation to packing details to cover insurance compensation in case of damage to any specific modules
- 7. Indicate separately price of spares listed above in terms of unit cost. The price of these spares will be included in the price comparison. Any additional spares recommended by the company will be considered for ordering but not included in the comparison. The buyer reserves the right to make the final decision on ordered spares
- 8. Indicate price for annual maintenance contract.
- 9. The payment will be by letter of credit: payable 80% on shipping, 20% after satisfactory installation and acceptance.
- 10. Indicate Delivery period.
- 11. Order will be placed on lowest bid from technically qualified vendor.
- > The tender documents can be sent at the following address:

Dr. Satyam Suwas Professor Department of Materials Engineering Indian Institute of Science, Bangalore 560012 Karnataka (INDIA)